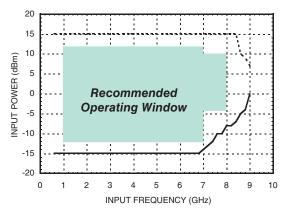
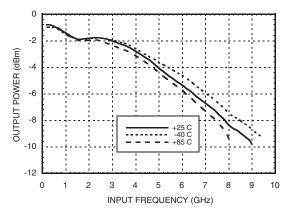




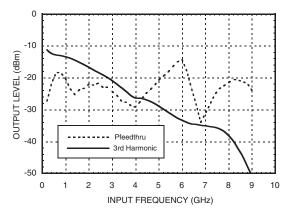
Input Sensitivity Window, T= 25 °C



Output Power vs. Temperature



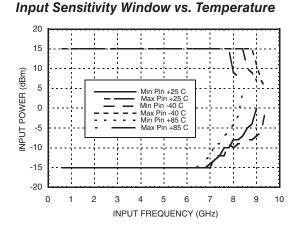
Output Harmonic Content, Pin= 0 dBm, T= 25 °C



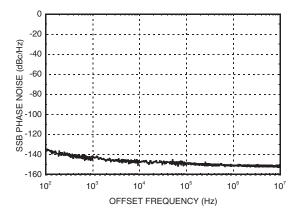


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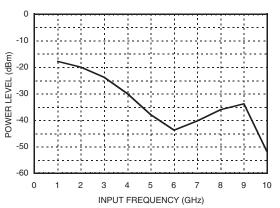
SMT GaAs HBT MMIC



SSB Phase Noise Performance, Pin= 0 dBm, T= 25 °C



Reverse Leakage, Pin= 0 dBm, T= 25 °C



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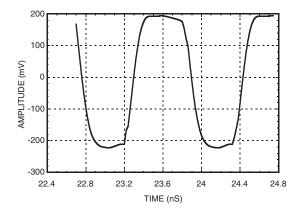


HMC432 / 432E

SMT GaAs HBT MMIC DIVIDE-BY-2, DC - 8 GHz



Output Voltage Waveform, Pin= 0 dBm, Fout= 882 MHz, T= 25 °C



Absolute Maximum Ratings

RF Input Power (Vcc = +3V)	15 dBm
Nominal +3V Supply to GND	-0.3V to 3.5V
Max Peak Flow Temperature	260 °C
Storage Temperature	-65 to +125 °C
ESD Sensitivity (HBM)	150 V

Reliability Information

Junction Temperature to Maintain 1 Million Hour MTTF	135 °C
Nominal Junction Temperature $(T = 85 \text{ °C})$	99 °C
Thermal Resistance (Junction to GND Paddle, 3V Supply)	108 °C/W
Operating Temperature	-40 to +85 °C

DC blocking capacitors are required at RF input and RF output ports. Choose value for lowest frequency of operation.



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Typical Supply Current vs. Vcc

Vcc (V)	Icc (mA)
2.70	34
3.00	42
3.30	50

Note: Divider will operate over full voltage range shown above

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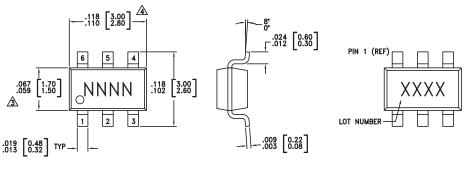


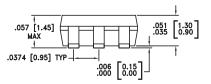
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SMT GaAs HBT MMIC DIVIDE-BY-2, DC - 8 GHz



Outline Drawing





NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- A DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- 5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC432	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H432 XXXX
HMC432E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	432E XXXX

[1] Max peak reflow temperature of 235 $^\circ\text{C}$

[2] Max peak reflow temperature of 260 $^\circ\text{C}$

[3] 4-Digit lot number XXXX

Pin Description

Pin Number	Function	Description	Interface Schematic
1, 4	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
2	GND	Pin must connect to RF/DC ground.	
3	IN	RF input must be DC blocked.	

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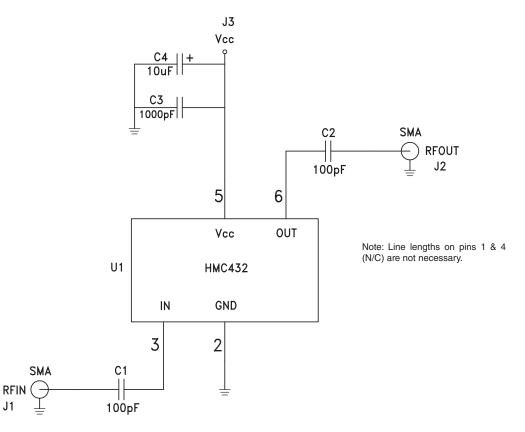
SMT GaAs HBT MMIC DIVIDE-BY-2, DC - 8 GHz



Pin Description (Continued)

Pin Number	Function	Description	Interface Schematic
5	Vcc	Supply voltage $3V \pm 0.3V$.	Vcc ○ 8pF 71∩ 71∩
6	OUT	Divided output must be DC blocked.	500 OUT

Application Circuit



Note:

J1

DC blocking capacitor values (C1, C2) and DC decoupling capacitor values (C3, C4) are chosen for lowest frequency of operation.

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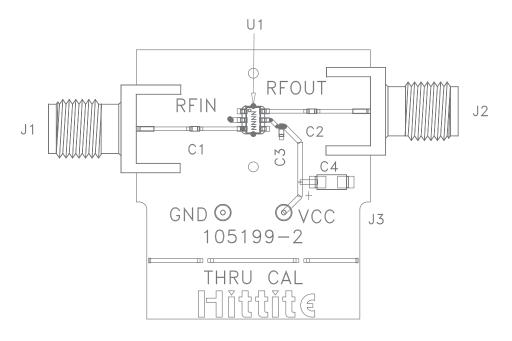
HMC432 / 432E

v04.0410



SMT GaAs HBT MMIC DIVIDE-BY-2, DC - 8 GHz

Evaluation PCB



List of Materials for Evaluation PCB 105675 [1]

Item	Description
J1 - J2	PCB Mount SMA RF Connector
J3 - J4	DC Pin
C1 - C2	100 pF Capacitor, 0402 Pkg.
C3	1000 pF Capacitor, 0402 Pkg.
C4	10 μF Tantalum Capacitor, 1206 Pkg.
U1	HMC432 / HMC432E Divide-by-2
PCB [2]	105199 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

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